CHAPTER 1

INTRODUCTION

Integrated Circuit (IC) technology has dominated the electronic world since their introduction in 1960s. Dr. Jack S. Kilby was awarded a Nobel Prize this year (2000) for his part in the invention of IC.

There were gradual advancements to the IC technology through Small Scale Integration (SSI), Medium Scale Integration (MSI), Large Scale Integration (LSI), Very Large Scale Integration (VLSI) technology that evolved in the 1970s and the most recent is Ultra Large Scale Integration (ULSI) technology. ULSI has made it possible to implement powerful and compact digital circuits at low cost, as now it is possible to build chips with millions of transistors [15]. New Computer Aided Design (CAD) tools are being used. Example, Simulation Program for Integrated Circuit Emphasis (SPICE) is used at the circuit level, and there are Hardware Description Languages (HDLs) that are used to describe and specify electronic systems at different levels of abstraction – ranging from behavioral down to structural level.

Application Specific Integrated Circuits (ASICs) [11] are specialized type of ICs that have evolved from the VLSI technology. ASIC evolved from a simple array of a few hundred logic gates into a complete family of full custom and semi custom ICs using more than 1 million logic gates. The main reasons for the popularity of ASICs are reduced board space requirements, reduced development cost, increased reliability, maximized performance, and security for new designs.

Full-custom ASICs are designed without using any precompiled or preprocessed silicon. The designer works at transistor level to optimize each cell for area and performance. They generally require a complete of standard steps for fabrication process. Whereas, semi-custom ASICs are preprocessed chips to which the designer only needs to add the final metal interconnection. The different types of semi-custom ASICs are Standard cell and Gate arrays.

Standard cells are pre-designed circuit functions at the LSI /VLSI level of complexity that can be joined by interconnecting cells. These are cheaper, when manufacturing more than 10,000 chips, as the Non-Recurring Engineering (NRE) costs are high. The NRE cost includes the cost of work done by the ASIC vendor and the cost of the masks. Gate arrays are preprocessed wafers of logic elements. These require only between one to three masking steps of metal interconnects to complete the fabrication process. These have columns of transistor arrays surrounded by inputs and outputs. The drawback of this type is the lack of flexibility to add complex functions; this is due to the difficulties in creating the signal routing channels.

Programmable devices are a type of semi-custom ASICs, which can have anyone of the architecture discussed above. These are general-purpose chips that can be configured for a wide variety of applications. The first of these kinds were the Programmable Read Only Memories (PROMs)[3], which were one-time programmable devices. The more recent versions are Programmable Logic Devices (PLDs), which have high speed and high performance logic gates. Step ahead in complexity to PLDs are the Field Programmable Gate Arrays (FPGAs) [15]. There is very little difference between an FPGA and a PLD; an FPGA is usually larger and more complex than a PLD. A FPGA typically consists of a two-dimensional array of logic blocks that can be connected by general interconnection resources. There are a lot of FPGA companies in the market. The major competitors are ALTERA and Xilinx. Table 1.1 shows the comparison between the architecture, the technology and the main products of these companies.

	ALTERA	Xilinx
Architecture	Deterministic Complex	Non-deterministic coarse
	PLDs	grain FPGAs
Programming	EEPROM	Static RAM
elements		
High density family	APEX 20KE series	Virtex series
Low cost family	ACEX series	SPARTAN – II series
Memory elements	Embedded Array Blocks (EABs)	Block SelectRAM
Logic blocks	Logic array blocks (product	Configurable logic blocks
	– term – based programming	(Look- up Table
	logic devices)	approach)
Maximum number of	1,520,640	1,000,000
gates available		
Maximum RAM bits	442,368	131,072
System gates	2,392,000	1,124,022
Logic cells	51,840	27,648
Maximum I/O bits	808	512
Voltage Levels	1.8V, 2.5V, 3.3V	2.5V, 3.3V
Dual-port memory	Two ports are used, one for	Same port is used to read
	reading and one for writing,	and write.
	so need two-memory blocks	
	(minimum).	
Special features	1.Content Addressable	1. On chip Digital
	Memory (CAM).	Delay-Locked Loops
	2. Mega-functions to model	(DLLs).
	memory.	2. Block RAM can
		be supplemented for
		external memory.

Table 1.1 Comparison of the ALTERA and XILINX architecture and products. [8]

The number of devices handled is very large; the popularity of HDLs has thus grown tremendously with the growing demands of ASICs in the electronic industry. Very High Speed Integrated Circuit (VHSIC) Hardware Description Language (VHDL)[5] has been the result of this high demand.

VHDL evolved in the US Department of Defense (DoD) in 1983. It was intended for documenting and modeling digital systems ranging from small chip to large systems. DoD made it public in 1985, and IEEE immediately adopted it. It was it as a standard in 1987, under 1076- 1987. It was further upgraded in 1993, the IEEE 1076-1993 standard [2]. There are a lot of synthesis tools too that help the designer to check his design. The designer creates a behavioral or structural model of his design, which can be synthesized by the synthesis tool. Thus the design verification and testing process is made a lot easier and faster. The important aspect of VHDL is that the behavior of the circuit is described and not the gates to be used, this makes the VHDL code independent of the technology [6]. Thus code written for one technology can be easily implemented into some other technology, example- the synthesis tool *SYNOPSIS* supports both Altera and Xilinx technology.

Some of the important applications of Field Programmable Logic Devices (FPLDs) are –image enhancement filters, signal processing for digital modulation and demodulation, direct digital signal synthesis, fuzzy logic embedded controllers and reconfigurable computing [16]. Reconfigurable computing technology is one of the upcoming applications. It is the ability to modify a computer system's hardware

architecture in real time. Instead of having ASIC, reconfigurable computing is an effort to build ICs that can be used for a set of applications after some minor reconfigurations [14]. Thus, parts of the algorithms are hardwired into the device and they are implemented on a function-by-function basis. Since these are implementations aimed at few applications, they offer tremendous acceleration over traditional programming solutions.

With such a wide variety of applications, FPLDs are easily available in market and this approach is found to be very economical too. The work presented in this thesis is one such application of FPLDs. The electronics design for D-zero detector at the Fermi National Acceleration Laboratory is to be used to trace the path of the particles emitted from the collision of a proton and anti-proton. This experiment has a large amount of data to be processed and the available processing time is just few microseconds. It was been proven that hardware based algorithms outperform software implementations, even though the processors executing the software are much faster than the hardware [17]. Thus hardware implementation is chosen for this project. The hardware design is developed using VHDL as the description language and implemented in ALTERA's FLEX 10KE FPLDs. The synthesis tool used is ALTERA's MAXPLUS II. This approach gives us the flexibility of software and speed of hardware.

In the thesis, Chapter 2 has a brief description about Fermi National Acceleration Laboratory, their activities and details about the D-zero (D0) project. There is also a summary of the implementation of the main data path. Chapter 3 describes the design and implementation of the main data path in detail. The Chapter 4 includes the simulation results of the VHDL model and the comparison of the results with a

MATLAB model of the design. Chapter 5 describes the different design approaches studied for some of the modules of the main data path. The concluding remarks about the work are in Chapter 6.

CHAPTER 2

THE D0 DETECTOR AT FERMI NATIONAL ACCELERATION LABORATORY

Fermi National Accelerator Laboratory (Fermilab) was founded in 1967 [10] and has been in the forefront in the exploration of fundamental nature of matter. The scientists at Fermilab utilize the latest technology to conduct research at the frontiers of high-energy physics and related disciplines. They are working towards finding the smallest elementary particles, which are the particles that cannot be divided into anything smaller.

Ordinary matter is made of atoms, which in turn contains electrons that orbit the nucleus, which is constituted of protons and neutrons. Electrons have been assumed as elementary particles, but protons and neutrons are made up of even smaller particles called quarks. The quarks are bound by a strong nuclear force, the binding energy that acts over a small distance and at a very large energy. The binding energy of the quarks is million times the binding energy of the atom. To be able to explore the internal structure of the quarks, there is a need to break their binding energy. This is achieved by using high-energy accelerators [10], for example the TeVatron accelerator at Fermilab. These are high-energy accelerators, but the number of particles accelerated at a time is very

small, thus the total energy is also small. The accelerated particles i.e. the proton and anti-proton are made to collide. This collision results in emission of the smaller particles that constitute the proton and anti-proton. To detect these emitted particles, Fermilab has two detectors on the TeVatron accelerator; they are the D0 detector and the CDF detector. These experiments have helped scientists to define the proton, a particle inside the atom's nucleus and identify its constituents i.e. the quarks. The first of the heavy quarks was bottom quark that was discovered in 1977 and more recent is the top quark that was discovered in 1995 [9]. The scientists predict that further study of the top quark may give clues about the mystery of why matter has mass. The top quarks are produced very rarely in the proton- anti-proton collision, thus to obtain a few positive events of top quark a few million events of the collision have to be scanned.

The D0 detector

The Silicon Track Card (STC) in the D0 detector electronics has been developed with the goal of finding events with top quarks. This goal will be achieved by finding the vertices of the particles in 3-dimensions with proper time resolution and fully reconstructing the decay chains [3]. The vertices are the points in space at which events occur. The primary vertex is the primary interaction point at which proton and anti-proton collide and produces new particles. The newly formed particles travel in space and then decay, such a point is called decay vertex or secondary vertex.

The detector has three levels of data acquisition and processing [7]. It uses different measurement techniques to help trace the decaying particles. These are calorimeter, fiber tracker, muon detector, pre-shower selectors and silicon detector chips.

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Figure 2.1 The flow of data in the D0 detector [D0 internal presentation].

The detector chips are silicon wafers made out as reverse biased p-n junctions and have aluminum strips for read out. They are located in the central region of the D0 trigger and are oriented in three different positions axial, stereo and z-axis. The axial position means parallel to the axis of cylinder of the detector, the stereo position means inclined by about 2 degrees with respect to the axial direction and the z-axis position means the chips are perpendicular to the axial direction.

Level_1

This level obtains measurement values from the calorimeter, fiber tracker, muon detector and the pre-shower [3]. It takes 128 different combinations of these measured values and feeds them to a series of FPGAs. The FPGAs examine this data to determine if a specific L1 bit has been satisfied, to issue an accept signal, which acts as a trigger for Level_2. This level helps to filter out the data, by giving a rough estimate of the group of tracks of the fiber-roads, through which the particle has passed, thus reducing the data to be processed by the next level by about 1000 times. This level runs at a frequency of 7.5 MHz.

Level_2

The trigger from Level 1 acts as a start signal for Level_2. The level runs are frequency of 5-10 kHz. The data from the silicon detector chips are digitized and passed on to Level_2. The digitization takes place in a full custom, mixed signal integrated circuit (SVX-II). These are hardwired directly to the detector. The charge, which is stored in terms of voltage across a capacitor, is digitized by the SVX-II to an 8 – bit word. Ten SVX-II chips are connected to High Density Interconnect (HDI) that is copper flexible printed circuit. Four HDIs are further connected to a one section of the Port Card and each Silicon Acquisition and Readout module (SAR) has two Port Cards. Finally a

maximum of 16 SARs can be mounted on a VERSAmodule Eurocard (VME) crate. Level_2 has eight VME crates around the detector. Thus Level_2 electronics has eight channels. Level_2 helps to locate a particular strip on the SVX-II chip through which the particle may have passed. The strip value from Level_2 and the fiber tracks from the Level_1 are compared in this level to eliminate data due to any stray particles. Finally, sophisticated Digital Signal Processing (DSP) microprocessors in the Track Fit Card (TFC) are used to run curve-fitting algorithms to find the decay chains of the emitted particles, top quarks in particular. Thus the data is further reduced by an order of 1000 times.



Figure 2.2 Block diagram of the Level 2.

Level_3

This is the final level in the D0 electronics. This is a data acquisition level that acquires data from each module of the both Level_1 and Level_2. This data is transferred to VME Receiver Card (VRC) on fiber using low-level fiber channel hardware [3]. The data transfer takes place only after the Level_2 accept signal is issued. This level runs at 1000 Hz.

The electronics for main data path [18]

The main data path is a part of Level_2. It performs the functions of preprocessing the SMT data, finding clusters and to associate the centroids with the Fiber Road Card (FRC) tracks. It has three modules Strip Reader, Centroid Finder, and the Hit Filter. This level also has a storage module L3 buffers.

Strip Reader

This is the front end of the data path. It has two sub-modules, SMT Data Filter and the Strip Reader Control. It accepts the 8- bit SMT data from the VME bus at the rate of 53MHz. This data is filtered of excess "C0" – end of event markers. The filtered data is corrected after checking for bad strips and a second check for the gain and offset values for the individual strips. At the output the Strip Reader formats the data obtained in a 23-bit word to be read by the Centroid Finder. The data is written into a 23-bit wide First In First Out (FIFO) bank of registers at the rate of 32Mhz. The format of the 23-bit register is given in Table 2.1 below.

Table 2.1 The 23-bit data at the output of the Strip Reader.

2221	20	19	1811	107	60
Data-type	New data	End of event	Data	SVX-II	Strip
	Bit	bit	Data	Chip ID	number

Centroid Finder

This module also runs at 32 MHz. It has two tasks (i) to determine a cluster and (ii) to find the centroid for the cluster. The two sub-modules in this module are Cluster Finder and the Centroid Calculator. The module has the ability to find three– or five–strips clusters, based on the requirements of a particular experiment. The Centroid Calculator algorithm finds the centroid depending on the centroid mass principle. These centroids are the strip addresses (SVX-II chip id (4) and strip number (7)), through which a particle is supposed to have passed. The data type of the centroid is also important for the study of the top quark as it indicates which direction (axial, stereo or z-axis) is represented by the data. Hence this is tagged along with centroid, when it is passed on to the Hit Filter. The centroids tagged with the end of event bit, data type, and the pulse area are stored in the FIFO at the end of the module in the format given in Table 2.2.

Table 2.2 The 17-bit data word from Centroid Finder to the Hit Filter.

17	1615	1413	120
End of	Data type	Pulse area	Centroid
event bit			

Hit Filter

The Hit Filter has 46 parallel Comparators that can hold a maximum of 46 pairs of the road groups from Level_1. The two road values represent the upper limit and the lower limit of the road groups. The centroid values are pulled out of the FIFO. Only the centroids with axial data-type are compared with the roads. The z-axis centroids are stored in this module to be readout by the hit interface module. The hits are the centroids

that match the road groups. These are also stored in a FIFO. The hit interface module reads them out.



Figure 2.3 The data flow in the main data path with reference to the modules in the

electronics.

L3 buffer

The L3 buffer is a group of five buffers that store the data processed at each step in the main data path. This data can be accessed for further analysis after the results from the Level_3 are obtained.

The five buffers are -

 Raw data: This buffer holds the filtered data coming out of the SMT Data Filter.

- Corrected data: The corrected data is the raw data checked for bad strips and also the data from the strips is processed for gain correction and offset correction.
- 3. Strip clusters: This buffer holds the data values and addresses of the strips that form the cluster, the threshold values used and the cluster type.
- 4. Centroids: The centroids calculated in the Centroid Calculator, with their data type are stored in this buffer.
- 5. Hits: This buffer holds the hits out of the Hit Filter.

Main control module

The main control module is the control unit that monitors the flow of data to and from the eight STC channels. This module is the gateway between the eight channels and the other electronics of the Level_2. The reading of hits and z- axis centroids from the Hit Filter, downloading the parameters in the channel memory and reading out the L3 buffers are some of the functions of this module. The hit interface module of each channel talks to this main control module.

With this background of the D0 detector and the part of the main data path in Level_2, the further chapters discuss the design methodologies and the implementation of the main data path.

CHAPTER 3

DETAILED DESCRIPTION OF THE MAIN DATA PATH

The main data path consists of three modules the Strip Reader, Centroid Finder and the Hit Filter. The data flow through each of the module and the data processing in the module is described in detail in this chapter.

Design features

The design is implemented in a FPLD and VHDL is used to describe the design behaviour. The design defines the logic for one channel of the Silicon Track Card (STC). Each STC has eight such identical channels operating in parallel. Each channel can be enabled or disabled according to incoming data from the experiment. The whole design (except for the Silicon Micro-strip Tracker (SMT) data filter) is designed to operate with system clock of frequency 32 MHz. The logic has a synchronous reset signal at startup that is used to initialize the design. All the modules are in their initial states and do not start the data processing till an EVENT_START signal is issued. The SMT Data Filter in the Strip Reader runs synchronously when the channel is enabled, and the Centroid Calculator in the Centroid Finder and the Comparator module in the Hit Filter run asynchronously when the channel is enabled. All the control modules are designed with the Moore type Finite State Machine (FSM) approach. A FSM is a state machine with finite number of states. The machine always resets into an initial state and updates states on each clock cycle. FIFO buffers are provided at the end of each module in the data path to maintain a synchronous data flow. The logic can process data for only one event, but the design can hold more than one event at the input in the SMT data, and output in the Hit Filter.

Design parameters

The parameters required for the data processing are unique for each channel. These parameters are downloaded in the channel memory on start up. The memory spaces are allocated to facilitate the main control logic to write into the memory and read out of the memory through a bi-directional bus. The control logic uses 15 address lines to access this memory space. The memory allocated area are as given in the Table 3.1.

Memory area	Memory space	Memory address
Monitor space	1K X 32	0000 – 03FF
Miscellaneous	1K X 32	0400 - 07 FF
Gain Offset LUT	4K X 8	0800 – 17FF
Test data LUT	256 X 18	1800 – 1BFF
	(1K min.)	
Empty Space (for future use)	_	1C00 – 3FFF
Road data LUT	16 K X 22	4000 – 7FFF

Table 3.1 Memory mapping for the single channel.

Monitor space

This space holds the monitoring counters from the Strip Reader and the Centroid Finder. These counters are defined as –

- 1. SMT counters
 - i. Mismatch Counter: This counter counts the number of times there was a mismatch in SEQ ID and HDI ID.
 - ii. SMT error (SERR) Counter: This counter keeps track of the error in reading the data VTM data.
 - iii. Zero Error Counter: This counter increments every time a byte of zeros is not present in the data stream after the SVX-II chip-id.
- 2. Chip activity counters: There are nine SVX-II chip activity counters, one for each SVX-II chip. The counter for the SVX-II chip is incremented when a strip from that SVX-II chip has data on it. Thus it is an indication of the activity on that SVX-II chip for an event.
- Cluster counters: There are three cluster counters, one for each data type.
 These counters count the number of clusters of each data type in an event.

Miscellaneous memory

The miscellaneous memory constitutes of bad channel memory, chip ranges, pulse area thresholds, clustering thresholds and the miscellaneous data register.

 Bad channel memory space having 64, 32 bit wide words is actually a Look Up Table (LUT). Addresses assigned to this memory space are from 0400 – 047F (HEX). This memory has the status of each of the 128 channels of every SVX-II chip in the detector. A channel is set to be bad on the basis of the technical survey of the detector, conducted in between runs. This status is used to eliminate any false readings on the channels.

- Chip range memory space is at address 0480 (HEX). This memory consists of 24-bit word. Each data type as a 4 bit upper range value and a 4-bit lower value for the SVX-II chips, thus forming the 24-bit wide word.
- 3. Pulse area threshold memory space is at the address locations 0500 0503 (HEX). This memory is 24-bit wide and holds the three threshold values Pulse_Threshold_1, Pulse_Threshold_2, and Pulse_Threshold_3 required to calculate the pulse area for the clusters found in the event. These values are unique for each data type.
- 4. Clustering thresholds are downloaded in memory locations 0600-0603 (HEX). These are the Threshold_1 and the Threshold_2 values used in the clustering algorithm. The data value Threshold_1 is minimum data value that should be on a strip to be considered as valid data. The data value threshold_2 is the minimum peak data value of a cluster to get a valid cluster from the strips.
- Miscellaneous data register is a 32-bit register downloaded at address location 0580(HEX). This register has the following parameters
 - i. Unique 8-bit SEQ ID for the channel.
 - ii. Unique 3–bit HDI ID for the channel.
 - iii. Delay: This is an 8-bit signal to indicate the delay between the FRC_START signal and the main EVENT_START signal.
 - iv. Disable bit: This bit indicates whether the channel is disabled.
 - v. SMT ID: This is 3-bit number, unique for each SMT data stream.

3128	27	2624	2316	158	70
Empty	Disable	SMT	Delay	SEQ	HDI
		ID		ID	ID

Table 3.2 Miscellaneous register downloaded at 0580 (HEX).

Gain offset memory

This memory holds the corrected data for each SVX-II chip in the detector, according to the gain and offset values for the SVX-II chips. This data is accessed with the SVX-II chip number and the data value for the strip.

Corrected data is calculated using following equation -

Corrected data = gain * actual data value + offset.

Test data LUT

The test data memory space holds the test data in the same format as the 18 - bit data stream (refer Table 3.3). This data stream is used to check the functionality of the design.

Road data LUT

The road data memory is an external memory space, which gives a unique pair of the roads (upper and lower) 11-bits wide defining a group of roads. The upper and lower road values are unique for each 17- bit road data value obtained from the Level_1 i.e. FRC, which represents a fiber road track.

Strip Reader

The Strip Reader module has two clocks; a SMT clock running at 53 MHz, to match the speed of the SMT data coming on the VME bus and the PCI System clock running at 32 MHz, this clock determines the flow of data through the design. The three sub modules in the Strip Reader are the SMT Data Filter, SMT Test Select and the Strip Reader Control.



Figure 3.1 The detailed block diagram of the Strip Reader module.

SMT Data Filter module

The SMT module gets input from the VME bus. The module has a state machine that filters out the excess data at the end of event. It also converts the 8-bit VTM data stream into 16-bit data word so that the system clock even though slower than the SMT data clock can match the speed of the input data stream. The SMT Data Filter runs continuously when the channel is enabled. Any error in reading the input data stream is indicated by setting one of two error bits, one each for the higher and the lower byte of the output stream. These errors bits are also passed on to the next sub module along with the 16 bit data, thus forming an 18-bit word that is stored in the FIFO, as given in Table 3.3.

Table 3.3 Data stream from SMT Data Filter to the Strip Reader Control.

1716	158	70			
Error bits	Higher byte	Lower byte			

Another task of this module is to determine the event number of the current data stream. This number is assigned after the FRC_START signal is received. This signal is used to synchronize the SMT data event and the road data event (from Level_1). The event number is tagged along with the end of event marker and written as the last word in the FIFO.

SMT Test Select module

This module uses the TEST input from the main control module to select between the test data stream downloaded in Test FIFO and the SMT data stream in the SMT FIFO. The hand shaking signals from the Strip Reader Control module to both the FIFOs are routed through this module.

Strip Reader Control module

The Strip Reader using a Moore type FSM (Reference flow chart in appendix A); reads the 18-bit data stream from the intermediate FIFO (refer Table 3.3). Each channel is configured to read the data stream from a unique SEQ and HDI. Thus the first word read out of the FIFO is checked for the correct SEQ ID and the HDI ID; if there is a mismatch, the mismatch counter is incremented and mismatch bit (MM) is set. The SVX-II chip-id is identified next with a byte of zeros following it. These are important to isolate the strips with data values from the SVX-II chips. If the byte of zero is absent the zero error counter is incremented. The data type is determined by comparing the SVX-II chip-id with available SVX-II chip ranges for the three data types. Chip activity counters are present in this module to keep track of the number of strips per SVX-II chip. Once this is done, the design starts processing the strip numbers and the data values. The gain-offset memory is then accessed using address as the SVX-II chip id concatenated with the data value to get the corrected data. Before formatting the 23-bit data word (refer Table 2.1) the strip number is compared with the bad channel memory and the strips that are set to be bad are assigned a zero data value. The corrected data and the zeroed bad channel strip with the data type, SVX-II chip-id and channel number are formatted into the 23-bit wide data word and written in the output FIFO (refer Table 2.1). An event covers many SVX-II chips but the same SEQ ID and the HDI ID. When an end of event marker is encountered, the state machine extracts the event number, which is the lower byte of the 18-bit word. The two error bits (refer Table 3.3) serve as an input to the SERR counter and are passed on as a single SERR bit.

Centroid Finder

The Centroid Finder module works at the frequency of system clock. This module has two sub-modules the Cluster Finder and the Centroid Calculator. This is the heart of the data processing in the main data path. This module finds the clusters from the strips and calculates the centroids. The detailed block diagram of this module is shown in Figure 3.2.



Figure 3.2-Detailed block of the Centroid Finder module.

Cluster Finder module

The Cluster Finder module has three tasks (i) interface with the output FIFO of the Strip Reader module, (ii) find the data clusters and (iii) pass on the strips of cluster to the Centroid Calculator module. It reads out the 23–bit word and splits it into its constituents (refer Table 2.1). The strips in a cluster should have - a data value greater

than or equal to Threshold_1, same data type and sequential addresses. The SVX-II chip id is concatenated with the strip number to form 11-bit strip address. The clusters are of five strips. There are five data and address buffers to store the data values and addresses of strips constituting a cluster. There are also two secondary data buffers and address buffers to store the shadow values in anticipation of a peak value greater than the one already found for a cluster. The first data value read is always stored in data buffer D3, which contains the peak value. The following data values after conferring to the above conditions are compared with data value in D3. If the new data value is greater than or equal to D3 then the peak is replaced or the following data buffers are filled, (reference flow chart appendix A). The final peak cluster value should be greater than or equal to Threshold_2.



Figure 3.3 An illustration example of a five-strip cluster.

The example in Figure 3.3 is an illustration of a five-strip cluster. All the registers are initialized to zero before reading data for a new cluster.

(i) Strip 2 loaded into D1, address in add 1 = (peak address - 2)

- (ii) Strip 3 loaded into D2, address in add 2 = (peak address 1)
- (iii) Strip 4 loaded into D3, peak data value and address in add3 = (peak address)
- (iv) Strip 5 loaded into D4, address in add 4 = (peak address + 1)
- (v) Strip 6 loaded into D5, address in add 5 = (peak address + 2)

The strip number 7 and 8 are stored in the shadow buffers B1 and B2. When the data value of strip number 9 is compared with D3 and found to be greater than data value of D3 the data buffers D1 and D2 are over written with the shadow buffers B1 and B2. The corresponding address buffers are also replaced. The data value of strip number 9 is written in to data buffer D3 and the strip address is written into add3 (i.e. the peak address).

So the new data buffers are -

- (i) Strip 7 loaded into D1, address in add 1 = (peak address 2)
- (ii) Strip 8 loaded into D2, address in add 2 = (peak address 1)
- (iii) Strip 9 loaded into D3, peak data value and address in add3 = (peak address)
- (iv) Strip 10 loaded into D4, address in add 4 = (peak address + 1)
- (v) Strip 11 loaded into D5, address in add5 = (peak address + 2)

The end of cluster is found at Strip 11, as data value of the Strip 12 is below Threshold_1. The number of strips used for the cluster is 5 and the number of strips checked is 11. The data values (8- bits each) and the address add2 (11- bits) are passed on to the Centroid Calculator.

Centroid Calculator module

This module takes the data values of the strips in a cluster from the Cluster Finder and performs the arithmetic calculation of finding the centroid using the centroid mass principle. The calculation for the three or five strip cluster is decided according to the cluster type bit.

In Figure 3.4 below, if D2 is viewed as the origin and D1, D3, D4 and D5 as point masses, the centroid of the system is [13]–



Figure 3.4 Realization of centroid calculation for a five-strip cluster [13].

The moment of the system is the mass times the distance from the origin:

- D2 + D4, -- for a three-strip cluster

- D1+D3+2D4+3D5, -- for a five-strip cluster

Thus, the centroid of the system is given by following equations

$$\frac{-D2 + D4}{D2 + D3 + D4}$$
 Centroid Calculation for three-strip cluster - (3.1)

 $\frac{-D1 + D3 + 2D4 + 3D5}{D1 + D2 + D3 + D4 + D5}$ Centroid Calculation for five-strip cluster - (3.2)

The centroid value obtained from these calculations is added to the Address add2 passed on from the Cluster Finder to get the exact address of the centroid for the cluster. The final centroid value is 13-bit wide, because of the addition of two precision bits from the calculation.

This module also finds the quantized pulse area of the cluster. The pulse area is calculated by summing the data values for all the strips constituting the cluster and comparing the sum to three threshold values stored in the channel memory [19]. Two bits are set to indicate the cluster pulse area according to the thresholds given in Table 3.4.

Table 3.4 The scheme for determining the pulse area of the cluster [19].

Bits	Pulse area
00	< Pulse_Threshold_1
01	\geq Pulse_Threshold_1, Pulse_Threshold_2 \leq
10	\geq Pulse Threshold 2, Pulse Threshold 3 \leq
11	\geq Pulse_Threshold_3

The centroid value its data type and pulse area are written into the output FIFO of the Centroid Finder (refer Table 2.2).

Hit Filter

The Hit Filter module handles the axial and the z-axis centroids. It stores the zaxis centroid in the z-centroid FIFO and compares the axial centroids with road data values to find the hits (refer Chapter 2 – Section Hit Filter). The Hit Filter module has six sub modules. They are Hit Filter Control module, Comparator module, Hit Register module, Hit Format module, Hit Readout module, and Z- centroid module. The module handles only the axial and z- axis type of centroids. The z- axis centroids are stored in a buffer, which can be accessed by the hit interface module and the axial type of centroids are compared with the roads from level –1 to find hits. The hits are written in the output FIFO from where they can be pulled out by the hit interface module to be passed on to the TFC.



Figure 3.5 Detailed block diagram of the Hit Filter module.

Hit Filter Control module

This module controls the processing in the Hit Filter. It is activated with an EVENT_START signal. The roads from the road data memory are loaded into the comparators sequentially on every road write signal. Since the roads are loaded

sequentially, each comparator corresponds to the track of Level_1. A masking register is created once all the roads are loaded into the comparators. This register masks all the comparator outputs that are not loaded. The module then reads one centroid at a time. The axial centroids are loaded into the comparators, while the z- axis centroids are passed on to the Z- centroid module. The output of the comparators is masked, and the valid hit register is passed on to the Hit Format module to find the hits and format them. The control module issues all the control signals for the processes comparing, masking and formatting. The control signals are LOAD_ROAD, READ_COMPARATOR and HITREG_VALID.

Z- centroids module

This module formats the z-centroids in a 32-bit format and stores them in a FIFO. The hit interface module reads out the centroids from the FIFO. The 32-bit word formed is given in Table 3.5.

31	3028	2726	2524	2316	1513	120
0	SMT	Data	Pulse	SEQ	HDI	Centroid
	ID	type	area	ID	ID	

Table 3.5 The 32-bit word format of the Z-centroids.

Comparator module

The Comparator module has 46 parallel comparators. It has a capability to compare 46 pairs of roads with each incoming axial centroid. The road pair of upper and

lower roads of 11-bit each is compared with 11-bit centroid value (the two precision bits are not used in the comparison, as the roads are defined as whole values).

Hit Register module

This module ANDs the output of the Comparators with the mask register to get a valid Hit Register for the each centroid when it receives a READ_COMPARATOR signal from the hit control module. This helps to filter out the false outputs from Comparators that are not loaded with roads.

Hit Format module

This module takes the valid 46-bit Hit Register when the hit control module issues the HITREG_VALID signal. The module checks for the hits serially. To make the scanning process faster, the register is split into five groups. The OR-ed output of each group indicates whether there is a hit in that group. The scanning of the register starts from the first group that has a hit, and then the logic goes through the rest of the register sequentially. The upper limit for this process is the number of Comparators loaded with roads. Whenever the bit is set, it is an indication of a hit for that particular track. The final output in the form of a 32-bit word (refer Table 3.6) is stored in the output FIFO of the Hit Filter module. At the end of hits for one centroid, the module waits for a next HITREG_VALID signal.

Table 3.6 The data format of the hits in the output FIFO.

31

3126	2524	2316	1513	120
Track number	Pulse area	SEQ ID	HDI ID	Centroid

At the end of event signal, a trailer (refer Table 3.7) is written into the FIFO. The module issues an independent end of event signal for the hit interface module.

Table 3.7 The data format of the trailer for the hits.

3127	26	25	2423	2119	181	108	70
					1		
11110	SERR	MM	-	SMT	SEQ	HDI ID	Event
				ID	ID		no.

Hit Readout module

This module includes the FIFO in which hits are written in a unique 32 – bit word format (refer Table 3.6). When the hit interface module issues a READ HITS signal, the read request signal of the FIFO is activated and the hits are given out on each clock cycle.

The design of the data path was amended in different ways to optimize the speed, memory required and the logic cells utilized. The various approaches used for different modules are discussed in the following chapter.

CHAPTER 4

SIMULATION RESULTS OF THE VHDL MODEL AND COMPARISON WITH A MATLAB MODEL

The VHDL simulation model is described with the help of a test vector derived from results of the previous experiments in D0. These results are then compared to a MATLAB model of the same design. Each step in the flow of data through the main data path is given with a detailed description of the inputs and outputs of each module.

The VHDL Model

The test vector is given as data entering the SMT Data Filter from the VME bus. The test vector is given in Table 4.1.

in hexadecimal.													
							Dire	ction of	the data	a stream	I		
AA	77	81	00	40	03	41	0D	42	06	50	06	51	10

05

10

6E

7E

04

09

6F

C0

03

C0

6D

7D

Table 4.1 Test vector for an example simulation of the data path

The data values are in HEX. This is a data stream of 8-bits each.

04

09

- The first byte is the SEQ ID "AA"
- The second is the HDI ID "77" •
- The third is the SVX-II chip id "81". The SVX-II chip id should be • followed by a byte of zeros – "00".

77

C0

07

C0

The data stream after the byte of zeros is a strip number and the corresponding data value alternatively. The flow of the data through each module is described with reference to the detailed description of each module in Chapter 3.

SMT Data Filter

52

78

07

06

6B

79

03

07

6C

7C

This module converts the 8-bit test data stream into 16-bit word and adds two error bits to it thus an 18-bit data stream comes out the filter. The data stream coming out is as shown in Table 4.2.

Error bits (2)	Higher Byte (8)	Lower byte (8)
(Binary)	(HEX)	(HEX)
00	AA	77
00	81	00
00	40	03
00	41	0D
00	42	06
00	50	06
00	51	10
00	52	07
00	6B	03
00	6C	04
00	6D	05
00	6E	04
00	6F	03
00	77	07
00	78	06
00	79	07
00	7C	09
00	7D	10
00	7E	09
00	CO	91

Table 4.2 Output stream from the SMT Data Filter.

The last word in this data output is the end of event marker "C0" (in HEX) and the event number "91" (in HEX) obtained from the FRC (refer Chapter 3 - Section SMT Data Filter).

Strip Reader Control

This module starts on the EVENT_START signal. It pulls out the 18-bit word out of the intermediate FIFO. It converts the stream into higher byte and lower byte. The module first checks for the channel specific SEQ ID in higher byte and HDI ID in the lower byte. It waits for a valid SVX-II chip id in higher byte and the byte of zeros in the lower byte in the second word of the data stream. The most significant bit (MSB) of the higher byte; in this case bit 8 of the higher byte should be high. The SVX-II chip id decides the data type of the following strips. The pair of strip number in higher byte and data value in lower byte follows. The corrected data is obtained by addressing the gain-offset memory with SVX-II chip id ("0001" – binary) and the data value. The bad channel information from the bad channel memory is matched with the strip number for each strip of the SVX-II chip. The resultant 23-bit word formed is as shown in Table 4.3.

Data type	New	End of	Data	Chip Id	Channel
(Binary)	data bit	event bit	(HEX)	(HEX)	ID (HEX)
(2-bits)	(1-bit)	(1-bit)	(8-bits)	(4-bits)	(7-bits)
10	1	0	03	1	40
10	0	0	0D	1	41
10	0	0	06	1	42
10	0	0	06	1	50
10	0	0	10	1	51
10	0	0	07	1	52
10	0	0	03	1	6B
10	0	0	04	1	6C
10	0	0	05	1	6D
10	0	0	04	1	6E
10	0	0	03	1	6F
10	0	0	07	1	77
10	0	0	06	1	78
10	0	0	09	1	79
10	0	0	07	1	7C
10	0	0	10	1	7D
10	0	1	09	1	7E

Table 4.3 Output stream from the Strip Reader Control module.

This chip is found to be of the axial data type, hence the data type is assigned as "10."

Cluster Finder

The Cluster Finder module gets each data value with its specific parameters packed as a 23-bit word. The module finds clusters according to the clustering algorithm as described in the flow chart attached in Appendix A.

The chart in Figure 4.1 shows the data values in the test data stream with the corresponding strip addresses, thus we can see from the chart clearly there will be five clusters in this data stream as is shown in the simulation results in Table 4.4.



Figure 4.1 The data values in the test data stream with the corresponding strip

addresses

Address	D1	D2	D3	D4	D5
of D2	(8 bits)				
(11 bits)					
0C0	00	03	0D	06	00
0D0	00	06	10	07	00
0EC	03	04	05	04	03
0F8	07	06	07	00	00
0FC	00	09	10	09	00

Table 4.4: The clusters found by the Cluster Finder module

Centroid Calculator

The Centroid Calculator module finds the centroid according to the formula presented in the Chapter 3 section Centroid Calculator. The cluster type bit decides the cluster type. In this example the bit is set to "1", hence we calculate a five-strip cluster. The centroids for each of the above clusters as found by the module are given in Table 4.5.

Data type	Pulse area	Centroid
(Binary)	(Binary)	(11 bits HEX.
		2 bits precision Binary)
10	11	0C1.00
10	11	0D1.00
10	11	0ED.01
10	11	0F8.10
10	11	0FD.01

Table 4.5: The centroids found by the Centroid Calculator module.

Hit Filter

The Hit Filter, after getting the EVENT_START signal, waits for the road data. It gets the road data from FRC. The example of the road data values is given in the Table 4.6. These are the values used to compare the centroid values obtained from the Centroid Calculator.

Table 4.6: The road data values extracted from the road-data, with respect to the 17 – bit

Lower road data	Upper road data
(HEX)	(HEX)
020	200
0B0	100
010	150
050	300

road-data value from FRC.

These road pairs are sequentially loaded into the Comparators. Each Comparator is assumed to have the same track number as the FRC track, as the roads come in sequentially. The Hit Filter now waits for the centroids to be processed. The processed centroids are read out one at a time. The z-axis type centroids are stored in a z-centroid FIFO, while the axial-type of centroid is loaded into the Comparators to find the hits. The hit format module reads out the Hit Register when they receive a hitreg_valid signal. The hits for each centroid are written out in the output FIFO in a 32- bit format. The hits in this example are given in Table 4.7 below.

Track	Pulse	Seq Id	HDI ID	Centroid	Precision
[3126]	Area	[2316	[1513]	[122]	[10]
(Binary)	[2524]	-]	(Binary)	(HEX)	(Binary)
· · · · ·	(Binary)	(HEX)			
000000	11	AA	111	0C1	00
000001	11	AA	111	0C1	00
000010	11	AA	111	0C1	00
000011	11	AA	111	0C1	00
000000	11	AA	111	0D1	00
000001	11	AA	111	0D1	00
000010	11	AA	111	0D1	00
000011	11	AA	111	0D1	00
000000	11	AA	111	0ED	01
000001	11	AA	111	0ED	01
000010	11	AA	111	0ED	01
000011	11	AA	111	0ED	01
000000	11	AA	111	0F8	10
000001	11	AA	111	0F8	10
000010	11	AA	111	0F8	10
000011	11	AA	111	0F8	10
000000	11	AA	111	0FD	01
000001	11	AA	111	0FD	01
000010	11	AA	111	0FD	01
000011	11	AA	111	0FD	01

Table 4.7 the hits obtained written in the output FIFO.

The whole data processing terminates at the Hit Filter. After the hits have been written in the hit output FIFO the channel waits for the hits to be read out by the hit interface module. Once the hits are read out the channel waits for next EVENT_START signal to start the data processing of new data stream on the VME bus.

The MATLAB model

The MATLAB model is functionally similar to the VHDL model, but it does not run synchronously. The model takes data from a file and stores the processed data in another file. This model was developed to generate test vectors for the different modules in the VHDL model. The downloaded parameters are given in the form of input when the program is run. The data generated by this module is in binary i.e. 0's and 1's. The data streams generated by this model were compared to the data streams obtained from the VHDL model. The MATLAB code written to realize this model is in the attached Appendix D. The MATLAB consists of SMT filter, Strip Reader, Cluster Finder, Centroid Calculator and the Hit Filter. The flow of data through each of these modules is explained in detail below.

Main design

This is the main design file used to run all module files sequentially. The modules access the downloaded parameters file and the other data files and the data streams are written into the respective data files.

Read downloaded parameter

This file is used to extract the downloaded parameters from the data file downloaded parameters.m and store them in the file down_data.m from where it accessed by the data processing modules.

SMT filter module

This module reads the HEX data stream from the file "vtm_data.m". The module converts the 8-bit data stream to 16-bit data word. The error bits are also provided along with the VTM data stream. The 18-bit data word formed (refer Table 4.2) is written in binary format in file "smt file.m".

Strip Reader

The Strip Reader module reads the data sequentially from either the smt_data.m file or the test_data.m file, depending on the test input, which is a user input. The SEQ ID, HDI ID, data type, gain and offset are accessed from the data file down_data.m. The data is processed to get the 23-bit word (refer Table 4.3) in binary format. This data is written into the file "strip data.m".

Cluster Finder

The Cluster Finder module takes the 23-bit word from file "strip_data.m" and finds the clusters according to the clustering algorithm in APPENDIX A. The threshold_1 and threshold_2 values are accessed from data file down_data.m. The data values of the five clusters with address of the data value in buffer 2 (i.e. peak address -1) are stored in the file "cluster data.m".

Centroid Calculator

The cluster type and the pulse area threshold values are accessed from data file down_data.m. The calculation of the centroid is carried out in decimal and then the result is converted into binary format. The result as in Table 4.6 is stored in the file "centroids_data.m" in binary format.

Hit Filter

The Hit Filter reads the road pairs from the file "roads_data.m" and the centroids tagged with their data type and the pulse area from the file "centroids_data.m". Each centroid is compared sequentially with each road pair and the output is written out in the file "hits.m". The output consists of the track number, pulse area and the centroid.

The VHDL module and the MATLAB module agree on the centroids and the hits. Thus the design is functionally correct. The MATLAB module thus helps to check functionality of each module individually as we can check the test streams at the end of each module. Thus the algorithmic approach helps to check the state approach taken in the VHDL model.

CHAPTER 5

DESIGN ISSUES FOR IMPLEMENTATION OF THE MAIN DATA PATH

The design for the main data path was developed using VHDL. Different design approaches were studied with the aim of developing a compact, functionally correct and fast design. The design approaches studied for the Hit Filter is presented, and the different design implementations approaches taken to fit the whole design (i.e. main data path with the L3 buffers) are also discussed in this chapter.

The Hit Filter design approaches

The Hit Filter was required to have the capability to compare 46 road data values with a centroid value at a time. Different combinations of parallel and serial implementations were studied. The results are consolidated in Table 5.1.

	No of filters in parallel	No of inputs	No of outputs	No. Of LCs
1	2	37	2	101
2.	4	39	4	199
3.	6	41	6	297
4.	8	43	8	395
5.	10	45	10	493
6.	12	47	12	591
7.	14	49	14	689
8.	16	51	16	787
9.	18	53	18	885
10.	20	55	20	983
11.	22	55	22	1081
12.	24	59	24	1179
13.	26	61	26	1277
14.	28	63	28	1375
15.	30	65	30	1473
16.	32	67	32	1571
17.	34	69	34	1669
18.	36	71	36	1767
19.	38	73	38	1865
20.	40	75	40	1963
21.	42	77	42	2061
22.	44	79	44	2159
23.	46	81	46	2257

Table 5.1: The result of comparison for putting filters in parallel

As can be observed from Table 5.1 the number of logic cells required increases linearly with the number of comparators put in parallel. If we have a serial and parallel combination of the comparators there is a time delay in the switching of the bus possession. Also this approach does not reduce the logic cells utilization. Thus, the final scheme of all 46 comparators in parallel was chosen for high-speed comparison. The outputs of the comparators are read out serially so that they can be put out in the required 32-word format.

The different implementation schemes of the overall design

The hardware implementation of the overall design, i.e., the main data path with the L3 buffers was tried in FLEX 10KE FPLDs. There also exists an external memory of 16 K for the road data.

During this implementation four design approaches were studied. These approaches are discussed in detail in this section.

Approach 1

The synthesis tool was allowed to fit the design in the minimum possible number of FPLDs. The tool required a minimum of five FPLDs as shown in Table 5.2.

Chip name	Chip	Inputs	Outputs	Memory	Logic	EABs
-	_	-	_	Bits	cells	
Strip_reader_	EPF10K200	241	187	24772	2003	22
hitfilter_13	EGC599-1			(25%)	(20%)	(91%)
_schematic						
Strip_reader_	EPF10K200	122	316	58752	4211	22
hitfilter_13	EGC599-1			(59%)	(42%)	(91%)
_schematic-1						
Strip_reader_	EPF10K30	42	37	4608	368	2
hitfilter_13	ETC144-1			(18%)	(21%)	(33%)
_schematic-2						
Strip_reader_	EPF10K30	59	63	8192	334	2
hitfilter_13	EQC208-1			(33%)	(19%)	(33%)
_schematic-3						
Strip_reader	EPF10K50	86	29	4324	2225	10
_hitfilter_13	EQC208-1			(10%)	(77%)	(100%)
_schematic-5						
Total				100648	9141	58

Table 5.2: Results of the compilation: Approach 1

The tool tried to fit in the memory blocks first and then the logic into the FPLDs thus chose the FPLDs according to the memory capacity first and then fitted the logic cells into these FPLDs. In this approach the sizes of the FPLDs is varying, which is not preferable for the design.

Approach 2

To study the behaviour of the synthesis tool, the Hit Filter forced to fit in one FPLD – Hitfilter_schematic, and the L3 buffers is also forced to fit in one FPLD – L3_schematic. The tool was allowed to fit the Strip Reader chip (i.e. the Strip Reader and the Cluster Finder modules) in as few FPLDs as possible. The results are as shown the Table 5.3.

Chip name	Chip	Inputs	Outputs	Memory	Logic	EABs
				Bits	cells	
Hitfilter	EPF10K100	87	170	10532	4340	12
_schematic	EBC356-1			(21%)	(86%)	(100%)
L3	EPF10K200	175	291	79424	2941	24
_schematic	EGC599-1			(80%)	(29%)	(100%)
Strip_reader	EPF10K200	169	123	10692	1860	19
_hitfilter_13	SFC484-1			(10%)	(18%)	(79%)
_schematic_1						
Total				100648	9141	55

Table 5.3: Results of the compilation: Approach 2

After fitting the assigned modules to their FPLDs the synthesis tool fitted the memories in the L3_schematic FPLD and the excess logic into the Hitfilter_schematic FPLD, thus fitting the whole design in three FPLDs. This approach is not acceptable as the logic for the Strip Reader is spread into three FPLDs and thus there will be additional propagation delay on critical signals.

Approach 3

In this approach, the synthesis tool was given some guidance by forcing the Hit Filter to fit in one FPLD – Hitfilter_schematic, the L3 buffers in one FPLD – L3_schematic. The Strip Reader with some memory modules is forced to fit in one FPLD – Strip_reader_chip-1 and the Cluster Finder with remaining memory modules is forced to fit in one FPLD – Strip_reader_chip-2. The results are given below in Table 5.4.

Chip name	Chip	Inputs	Outputs	Memory	Logic	EABs
	_	_		Bits	cells	
Hitfilter	EPF10K100	77	144	10532	4012	12
_schematic	EBC356-1			(21%)	(80%)	(100%)
L3	EPF10K130	183	175	40960	1576	13
_schematic	EFC484-1			(62%)	(23%)	(81%)
Strip_reader	EPF10K200	179	216	45120	3244	18
_chip-1	EGC599-1			(45%)	(32%)	(75%)
Strip_reader	EPF10K130	124	183	4036	309	14
_chip-2	EFC484-1			(6%)	(4%)	(87%)
Total				100648	9141	57

Table 5.4: Results of the compilation: Approach 3

The Strip Reader requires two FPLDs as each memory space when assigned to an Embedded Array Block (EAB) utilizes minimum of two EABs. Thus even the small memory spaces were using 2 EABs even though the actual space utilized was 2-3 words maximum 32 bit wide. Thus the whole design fitted successfully in four FPLDs. Thus, the Approach 4 was taken to reduce the number of FPLDs.

Approach 4

From the conclusion of Approach 3 the EAB assignment of the small memory modules was removed and they were implemented using logic cells. The results for the design with the changes are given in Table 5.5.

Chip name	Chip	Inputs	Outputs	Memory	Logic	EABs
				Bits	cells	
Hitfilter	EPF10K100	77	144	10532	4012	12
_Schematic	EBC356-1			(21%)	(80%)	(100%)
L3	EPF10K130	183	175	40960	1576	13
_Schematic	EFC484-1			(62%)	(23%)	(81%)
Strip_reader_	EPF10K200	76	174	45120	4773	17
chip_schematic	SBC356-1			(45%)	(47%)	(70%)
Total				96612	10361	42

Table 5.5: Results of the compilation: Approach 4

The design is now found to fit successfully in three FPLDs which are very close to each other in size, thus for the final layout the largest FPLD of the FLEX10KE family can be chosen to permit further changes in the design. Since the logic cells replaced some of the EABs, a comparison of the change in the number of memory bits used and the logic cells utilized to substitute the EABs is given in Figure 5.1, Figure 5.2 and Figure 5.3, where 1 denotes approaches 1, 2, 3 and 2 denotes approach 4.



Figure 5.1 Comparison of the memory bits utilized



Figure 5.2 Comparison of the logic cells utilized



Figure 5.3 Comparison of the EABs utilized

Implementation of the design using Quartus software

The design presented in this thesis is for one STC channel of the Level_2 of the D0 detector. There will be eight such identical channels running in parallel (refer Chapter

2 – Section "Level_2"). All the channels are proposed to fit on to one Printed Circuit Board (PCB).

The design is successfully fitted in three FPLDs, but this amounts to 24 FPLDs for the eight STC channels and additional FPLD for the Main Control module (refer Chapter 2- Section "Main Control module"). Therefore 25 FPLDs should be fitted on to one PCB. This is not a difficult task, but the size of the PCB required will be really large and this is not suitable for the design. Thus a new approach has been examined to fit the whole design in a single APEX20KE FPLDs.

The APEX20KE is one of the latest FPLDs offered by ALTERA. The synthesis tool used for implementing the design in the APEX20KE is *QUARTUS*. The strip reader module with bad channel memory, gain offset memory, test data memory and the monitor space was successfully implemented in an APEX20KE. The results of this implementation are shown in Table 5.6.

Device name	EP20K300EBC652-1
Logic elements	2643/11520 (22%)
Pins	395/408 (96%)
Memory bits	49024 /147456 (33%)
ESBs	28/72 (38%)

Table 5.6 Implementation of the Strip Reader module in APEX 20KE.

The APEX20KE family has chips of high memory capacity and large number of logic elements. The specifications of the largest FPLD available in this family are given in Table 5.7.

Table 5.7 Specifications of EP20K1500E

Voltages	2.5 V and 1.8 V
Maximum system gates	2,392,000
Typical gates	1,500,000
Logic Elements	51,840
ESBs	216
Maximum RAM bits	442,368
Maximum macro-cells	3,456
Maximum user I/O pins	808

(Largest FPLD in APEX20KE family) [1].

CHAPTER 6

CONCLUSIONS

Recent technological advances have resulted in an increased number of gates in a single FPLD. Thus, VHDL is playing a key role in FPLD design. Since VHDL is a technology- and process-independent programming language, designers can work without the constraints of working with a single vendor. VHDL is a standard hardware description language accepted by IEEE, thus a design for a FPLD using one vendor's synthesis tool can easily be implemented in another vendor's FPLD. It has helped the designers to work on a high level of abstraction, enhancing the level of design complexity. The synthesis tools help to minimize the design-size, and thus it is possible to have complex and compact designs.

This thesis describes the implementation of the main data path that constitutes one channel of the STC card in the Level_2 of the D0 detector at Fermi National Acceleration Laboratory. VHDL is used to describe the behavioral model of the design and the design is implemented in FLEX10K FPLDs. First, the functional correctness of the design was verified, and then timing studies were conducted on the design. When implemented in the low-memory FLEX10K FPLD, the design requires three FPLDs per channel of STC, and the timing requirements are not met.

The Strip Reader module was alone implemented in the APEX20K family by ALTERA Corporation. This family has high density and large memory capacity. The results obtained from the implementation were used to predict the resources required for one channel of STC. The results show that three channels of STC can be implemented in one EP20K1500E, which the largest device available in the APEX20K family. The new design implementation will be able to meet the design requirements, as the propagation delays on the signals will decrease, as there wont be many inter FPLD connections. In addition the APEX20K FPLD family, the Virtex family by XILINX is also a good option for use as the larger FPLD (refer Table 1.1).